Inductors



Product Class:	B82451LxxxxAxxxx
Date	28.11.2018
IMDS ID if available	
Version:	01

Product Part (IMDS: semi component)	Material Class (IMDS: Material)	Material (Classification) VDA 231	Substance	TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)
Active Part	Ceramic	4B	Ni-Zn Ferrite	100	12645-50-0	34	
	Heavy Metal	1C	Cu	100	7440-50-8	42	
	Elastomer	2B	Polyurethane (PUR)	100	9009-54-5	5	
Encapsulation and Mounting	Thermoplastic	2A	Liquid Crystal Polymer (LCP)	60~70	90967-43-4	40	
			Glass fiber	30~40	65997-17-3	12	
	Organic, solid	5B	Quartz	30-50	14808-60-7		
			Dimethylvinylated and trimethylated silica	15-35	68988-89-6	5	
			Dimethyl siloxane, dimethylvinyl-terminated	40-60	68083-19-2		
Termination	Heavy Metal	1C	Cu	94	7440-50-8	4.0	
			Sn	6	7440-31-5	1.8	
	Heavy Metal	1C	Sn	100	7440-31-5	0.2	
	•	•			Sum in total:	100.0	•
Size W x L x H	Weight	Part Numbers					

[max. in mm] [approx. in g]

10x10x3.2

oprox. in g] 0.9 B82451L1505A400

Not part of	a Product Class							
Contact	Dr. Johann Reindl, MAG EPQM			Important remarks:				
Division	TDK Electronics AG, Magnetics Business Group (MAG)			The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906) Traces are				
Address	Rosenheimer Strasse 116b, 81669 Munich			product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated				
	Tel: +49 89 54020 3030	mailto: johann.reindl@tdk-electronics.tdk.com	2)	This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are				
*) others: .(not declarable or prohibited substances acc. GADSL)				based on our best present knowledge and cannot be regarded as binding statement binding product specifications, unless otherwise explicitly agreed in writing. TDK				
**) typical mass percentage of substance				ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY				
***) part number marked with 1 means not contains epoxy resin.				REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.				
				roducts are compatible with the requirements according to Art. 4 (substance restrictions) of				
Directive 2011/65/EU of the European Parliament and of the Council of June 8 th , 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.								

RoHS - Exemptions for the Product Class / Product according to Annex III: (🗹 valid 🗅 not valid)

☑ no exemptions;

Exemption 6 (a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;

Exemption 6 (b): Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;

Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;

Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);

Exemption 7 (c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound;

Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;

Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;

Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;

Conter Exemption than above